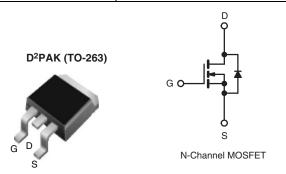
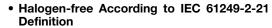
Vishay Siliconix

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	7 _{DS} (V) at T _J max. 700			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.145			
Q _g max. (nC)	122			
Q _{gs} (nC)	21			
Q _{gd} (nC)	37			
Configuration	Single			



FEATURES





FREE

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- · Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_g)
- Avalanche Energy Rated (UIS)
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB24N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650		
Gate-Source Voltage			.,	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V_{GS}	30		
Continuous Drain Current (T,I = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	24		
Continuous Drain Current (1) = 150 °C)		T _C = 100 °C		16	Α	
Pulsed Drain Current ^a			I _{DM}	70		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	508	mJ	
Maximum Power Dissipation			P_{D}	250	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	37	V/ns	
Reverse Diode dV/dt ^d			av/at	11	7 7/115	
Soldering Recommendations (Peak Temperature) for 10 s				300°	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 6 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		ı			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} :	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
	_	V _{DS} :	= 650 V, V _{GS} = 0 V	-	-	1	†
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} = 520 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.120	0.145	Ω
Forward Transconductance	9 _{fs}	V _D	_S = 8 V, I _D = 5 A	-	7.1	-	S
Dynamic				ı			
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	2740	-	
Output Capacitance	C _{oss}	1	$V_{DS} = 100 \text{ V},$	-	122	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	
Total Gate Charge	Qg			-	81	122	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 24 \text{ A}, V_{DS} = 520 \text{ V}$	-	21	-	
Gate-Drain Charge	Q _{gd}			-	37	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 520 V, I _D = 24 A,		-	24	48	ns
Rise Time	t _r			-	84	126	
Turn-Off Delay Time	t _{d(off)}		$V_{DD} = 520 \text{ V}, I_D = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, R_a = 9.1 \Omega$		70	105	
Fall Time	t _f		· ·	-	69	104	1
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.68	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	24	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	96	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 24 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 24 A, dl/dt = 100 A/μs, V _R = 20 V		-	517	-	ns
Reverse Recovery Charge	Q _{rr}			-	9.7	-	μC
Reverse Recovery Current	I _{RBM}			-	30	-	Α

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

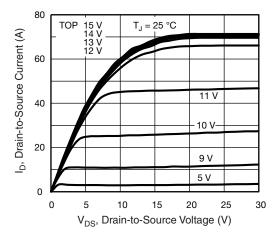


Fig. 1 - Typical Output Characteristics

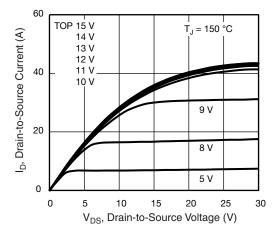


Fig. 2 - Typical Output Characteristics

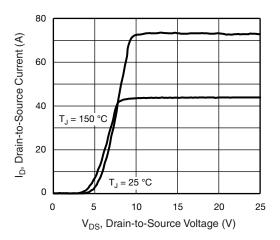


Fig. 3 - Typical Transfer Characteristics

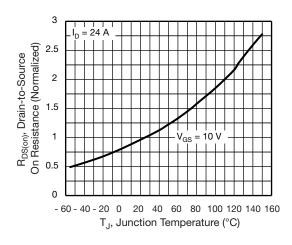


Fig. 4 - Normalized On-Resistance vs. Temperature

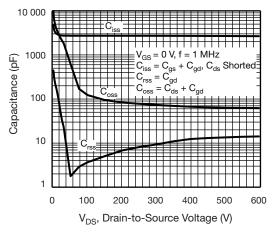


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

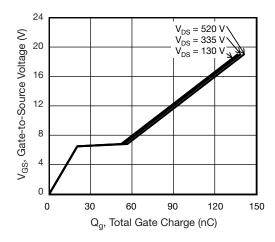


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



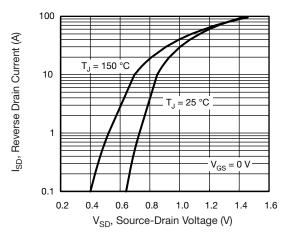


Fig. 7 - Typical Source-Drain Diode Forward Voltage

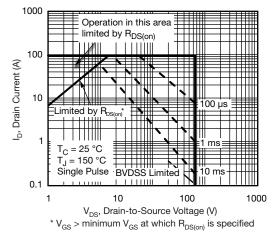


Fig. 8 - Maximum Safe Operating Area

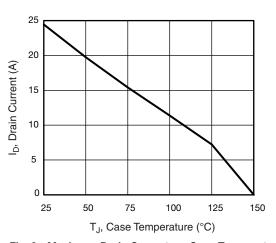


Fig. 9 - Maximum Drain Current vs. Case Temperature

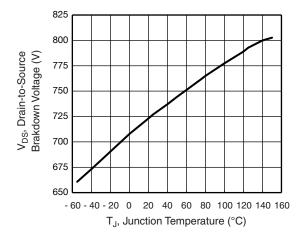


Fig. 10 - Temperature vs. Drain-to-Source Voltage

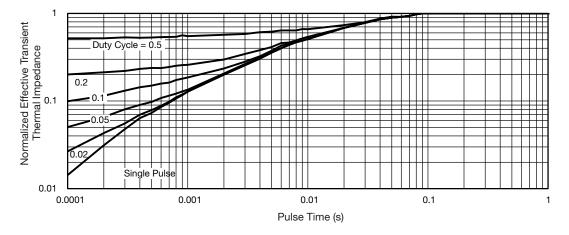


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



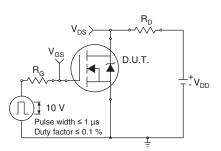


Fig. 12 - Switching Time Test Circuit

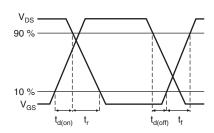


Fig. 13 - Switching Time Waveforms

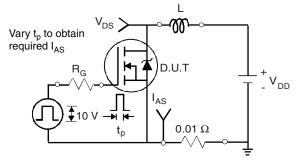


Fig. 14 - Unclamped Inductive Test Circuit

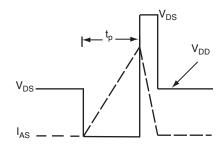


Fig. 15 - Unclamped Inductive Waveforms

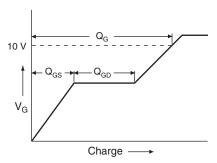


Fig. 16 - Basic Gate Charge Waveform

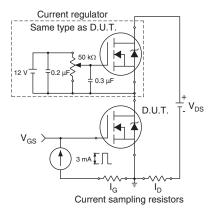
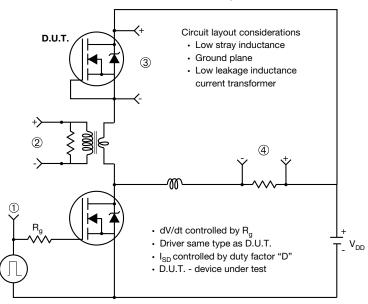


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



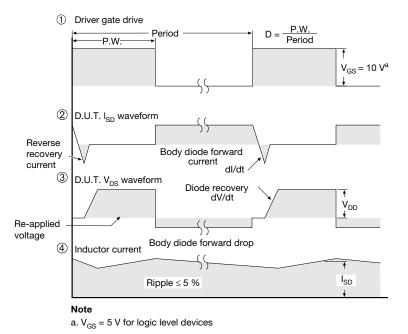


Fig. 18 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91477.

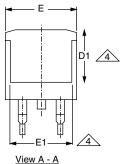




TO-263AB (HIGH VOLTAGE)







	i ↑
	D1 4
	Y
 	
$\parallel \Downarrow \top \Downarrow \parallel$	
Џ Џ 	
E1-	

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	6.86	-	0.270	-	
Е	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	-	
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	-	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





Vishay

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